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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Park et al.

Docket No.: TI-35623

Serial No.: 10/628,198

Art Unit: 2814

Filed: 07/28/2003

Examiner: Peralta, Ginette

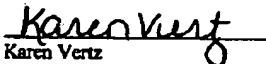
Title: A Two-Step Semiconductor Manufacturing Process For Copper Interconnects

AMENDMENT UNDER 37 C.F.R. §1.116

June 21, 2005

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Commissioner:

|   |                        |
|---|------------------------|
| <b>CERTIFICATION OF FACSIMILE TRANSMISSION</b>  |                        |
| I hereby certify that the above correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below. |                        |
| <br>Karen Vertz   | <u>6-21-05</u><br>Date |

In response to the Office Action, dated 02/22/2005, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Please charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.